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Vishay Semiconductors

RoHS

HALOGEN

FREE

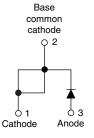
# Ultrafast Soft Recovery Diode, 60 A FRED Pt®

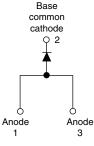




TO-247AC modified

TO-247AC





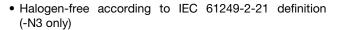
VS-60EPU02PbF VS-60EPU02-N3

VS-60APU02PbF VS-60APU02-N3

PRODUCT SUMMARY					
Package	TO-247AC,				
rackage	TO-247AC modified (2 pins)				
I <sub>F(AV)</sub>	60 A				
$V_{R}$	200 V				
V <sub>F</sub> at I <sub>F</sub>	1.08 V				
t <sub>rr</sub> typ.	See Recovery table				
T <sub>J</sub> max.	175 °C				
Diode variation	Single die				

#### **FEATURES**

- · Ultrafast recovery time
- Low forward voltage drop
- 175 °C operating junction temperature
- Output rectification
- Compliant to RoHS Directive 2002/95/EC
- Designed and qualified according to JEDEC-JESD47



#### **BENEFITS**

- · Reduced RFI and EMI
- Higher frequency operation
- · Reduced snubbing
- Reduced parts count

#### **DESCRIPTION/APPLICATIONS**

These diodes are optimized to reduce losses and EMI/RFI in high frequency power conditioning systems.

The softness of the recovery eliminates the need for a snubber in most applications. These devices are ideally suited for HF welding, power converters and other applications where switching losses are not significant portion of the total losses.

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Cathode to anode voltage	V <sub>R</sub>		200	V		
Continuous forward current	I <sub>F(AV)</sub>	T <sub>C</sub> = 127 °C	60			
Single pulse forward current	I <sub>FSM</sub>	T <sub>C</sub> = 25 °C	800	Α		
Maximum repetitive forward current	I <sub>FRM</sub>	Square wave, 20 kHz	120			
Operating junction and storage temperatures	T <sub>J</sub> , T <sub>Stg</sub>		- 55 to 175	°C		

<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Breakdown voltage, blocking voltage	V <sub>BR</sub> , V <sub>R</sub>	I <sub>R</sub> = 100 μA	200	-	-	.,	
Converd veltage	V <sub>F</sub>	I <sub>F</sub> = 60 A	-	0.98	1.08	V	
Forward voltage		I <sub>F</sub> = 60 A, T <sub>J</sub> = 175 °C	-	0.81	0.88		
D last		$V_R = V_R$ rated	-	-	50	μΑ	
Reverse leakage current	I <sub>R</sub>	$T_J = 150  ^{\circ}\text{C},  V_R = V_R  \text{rated}$	-	-	2	mA	
Junction capacitance	C <sub>T</sub>	V <sub>R</sub> = 200 V	-	87	-	pF	
Series inductance	L <sub>S</sub>	Measured lead to lead 5 mm from package body	-	8.0	-	nH	



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<b>DYNAMIC RECOVERY CHARACTERISTICS</b> (T <sub>C</sub> = 25 °C unless otherwise specified)								
PARAMETER	SYMBOL	TEST CO	NDITIONS	MIN.	TYP.	MAX.	UNITS	
		$I_F = 1.0 A, dI_F/dt =$	200 A/μs, V <sub>R</sub> = 30 V	=	-	35		
Reverse recovery time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C		=	28	-	ns	
		T <sub>J</sub> = 125 °C	I <sub>F</sub> = 60 A dI <sub>F</sub> /dt = 200 A/μs V <sub>R</sub> = 160 V	=	50	-		
Peak recovery current	I <sub>RRM</sub>	T <sub>J</sub> = 25 °C		-	4	-	Α	
		T <sub>J</sub> = 125 °C		-	8	-	^	
Reverse recovery charge	0	T <sub>J</sub> = 25 °C		=	59	-	~C	
	$Q_{rr}$	T <sub>J</sub> = 125 °C		=	220	-	nC	

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Thermal resistance, junction to case	R <sub>thJC</sub>		-	-	0.70	K/W	
Thermal resistance, case to heatsink	R <sub>thCS</sub>	Mounting surface, flat, smooth and greased	-	0.2	-	F\/ VV	
Weight			-	5.5	-	g	
vveignit			-	0.2	-	OZ.	
Mounting torque			-	-	1.2	N · m	
Madina decina		Case style TO-247AC modified	60EPU02				
Marking device		Case style TO-247AC		60AF	PU02		

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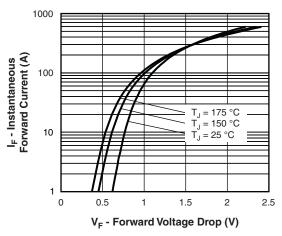


Fig. 1 - Typical Forward Voltage Drop Characteristics

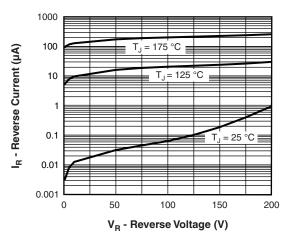


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

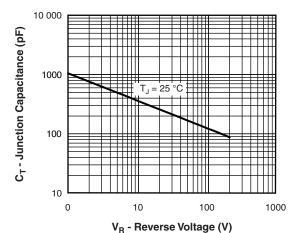


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

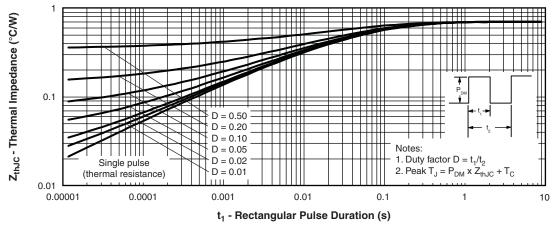


Fig. 4 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics



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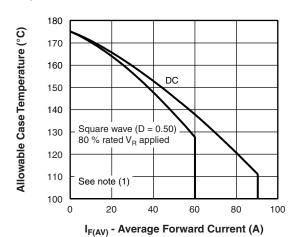


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

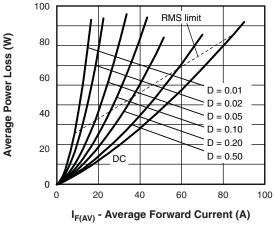


Fig. 6 - Forward Power Loss Characteristics

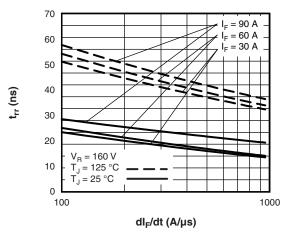


Fig. 7 - Typical Reverse Recovery Time vs. dl<sub>F</sub>/dt

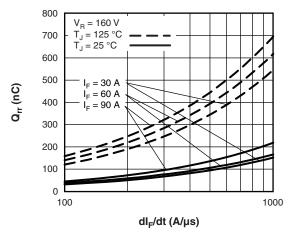


Fig. 8 - Typical Stored Charge vs. dl<sub>F</sub>/dt

#### Note

 $^{(1)}$  Formula used: T<sub>C</sub> = T<sub>J</sub> - (Pd + Pd<sub>REV</sub>) x R<sub>thJC</sub>; Pd = Forward power loss = I<sub>F(AV)</sub> x V<sub>FM</sub> at (I<sub>F(AV)</sub>/D) (see fig. 6); Pd<sub>REV</sub> = Inverse power loss = V<sub>R1</sub> x I<sub>R</sub> (1 - D); I<sub>R</sub> at V<sub>R1</sub> = 80 % rated V<sub>R</sub>

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# VS-60EPU02PbF, VS-60EPU02-N3, VS-60APU02PbF, VS-60APU02-N3

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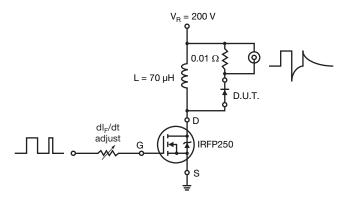
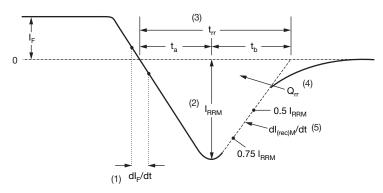


Fig. 9 - Reverse Recovery Parameter Test Circuit



- (1) dl<sub>F</sub>/dt rate of change of current through zero crossing
- (2) I<sub>RRM</sub> peak reverse recovery current
- (3)  $\rm t_{rr}$  reverse recovery time measured from zero crossing point of negative going  $\rm I_F$  to point where a line passing through 0.75  $\rm I_{RRM}$  and 0.50  $\rm I_{RRM}$  extrapolated to zero current.
- (4)  $Q_{rr}$  area under curve defined by  $t_{rr}$  and  $I_{RRM}$

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

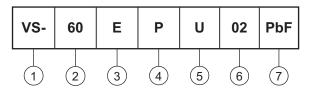
(5) dl<sub>(rec)M</sub>/dt - peak rate of change of current during t<sub>b</sub> portion of t<sub>rr</sub>

Fig. 10 - Reverse Recovery Waveform and Definitions

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### **ORDERING INFORMATION TABLE**

**Device code** 



1 - Vishay Semiconductors product

2 - Current rating (60 = 60 A)

3 - Circuit configuration:

• E = Single diode

• A = Single diode, 3 pins

4 - Package:

P = TO-247AC (modified)

5 - Type of silicon:

U = Ultrafast recovery

6 - Voltage rating (02 = 200 V)

7 - Environmental digit:

PbF = Lead (Pb)-free and RoHS compliant

-N3 = Halogen-free, RoHS compliant and totally lead (Pb)-free

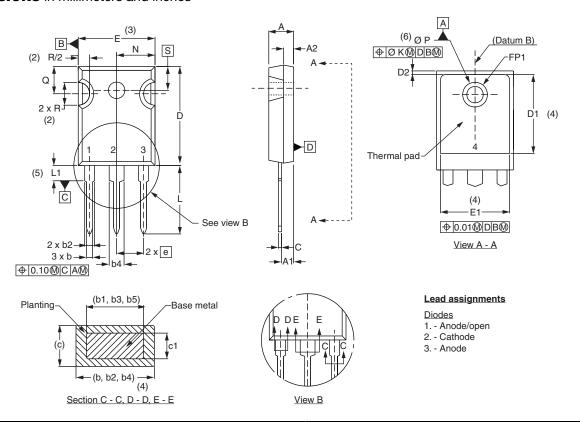
ORDERING INFORMATION (Example)							
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION				
VS-60EPU02PbF	25	500	Antistatic plastic tube				
VS-60EPU02-N3	25	500	Antistatic plastic tube				
VS-60APU02PbF	25	500	Antistatic plastic tube				
VS-60APU02-N3	25	500	Antistatic plastic tube				

LINKS TO RELATED DOCUMENTS					
Dimensions	TO-247AC modified	www.vishay.com/doc?95253			
Differsions	TO-247AC	www.vishay.com/doc?95223			
	TO-247AC modified PbF	www.vishay.com/doc?95255			
Part marking information	TO-247AC modified -N3	www.vishay.com/doc?95442			
Fart marking imormation	TO-247ACPbF	www.vishay.com/doc?95226			
	TO-247AC-N3	www.vishay.com/doc?95007			
SPICE model		www.vishay.com/doc?95416			



### Vishay Semiconductors

### **DIMENSIONS** in millimeters and inches



SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.65	5.31	0.183	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.50	2.49	0.059	0.098	
b	0.99	1.40	0.039	0.055	
b1	0.99	1.35	0.039	0.053	
b2	1.65	2.39	0.065	0.094	
b3	1.65	2.37	0.065	0.094	
b4	2.59	3.43	0.102	0.135	
b5	2.59	3.38	0.102	0.133	
С	0.38	0.86	0.015	0.034	
c1	0.38	0.76	0.015	0.030	
D	19.71	20.70	0.776	0.815	3
D1	13.08	-	0.515	-	4

SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
D2	0.51	1.30	0.020	0.051	
E	15.29	15.87	0.602	0.625	3
E1	13.72	-	0.540	-	
е	5.46	BSC	0.215	BSC	
FK	2.	2.54		0.010	
L	14.20	16.10	0.559	0.634	
L1	3.71	4.29	0.146	0.169	
N	7.62 BSC		0	.3	
ΦР	3.56	3.66	0.14	0.144	
ФР1	-	6.98	-	0.275	
Q	5.31	5.69	0.209	0.224	
R	4.52	5.49	1.78	0.216	
S	5.51	BSC	0.217	BSC	

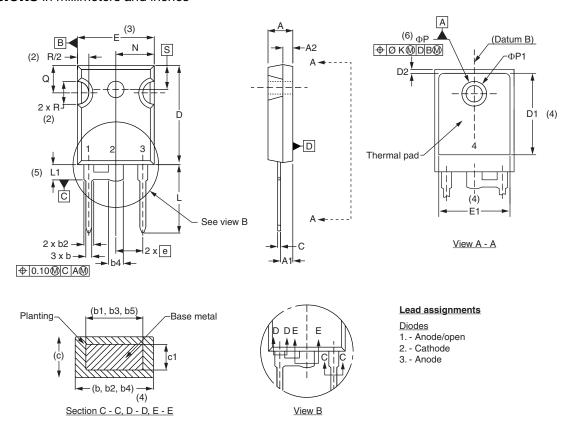
#### **Notes**

- $^{(1)}$  Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC outline TO-247 with exception of dimension c



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L	14.20	16.10	0.559	0.634	
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Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.